

DATA SHEET

74ALS112A

Dual J-K negative edge-triggered flip-flop

Product specification

1996 June 27

IC05 Data Handbook

Dual J-K negative edge-triggered flip-flop

74ALS112A

DESCRIPTION

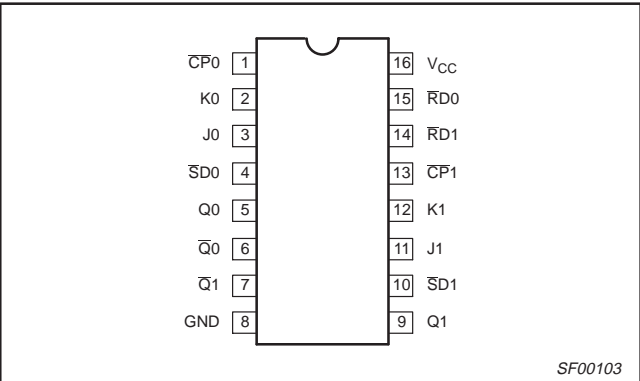
The 74ALS112A, dual negative edge-triggered JK-type flip-flop features individual J, K, clock ($\overline{CP_n}$), set (\overline{SD}), and reset (\overline{RD}) inputs, true (Q_n) and complementary ($\overline{Q_n}$) outputs.

The \overline{SD} and \overline{RD} inputs, when Low, set or reset the outputs as shown in the function table regardless of the level at the other inputs.

A High level on the clock ($\overline{CP_n}$) input enables the J and K inputs and data will be accepted. The logic levels at the J and K inputs may be allowed to change while the $\overline{CP_n}$ is High and the flip-flop will perform according to the function table as long as minimum setup and hold times are observed. Output changes are initiated by the High-to-Low transition of the $\overline{CP_n}$.

TYPE	TYPICAL f_{MAX}	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS112A	50MHz	3.0mA

PIN CONFIGURATION



ORDERING INFORMATION

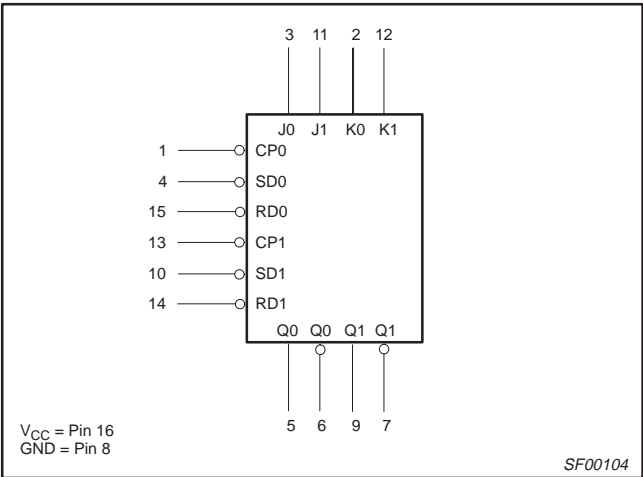
DESCRIPTION	ORDER CODE	DRAWING NUMBER
	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$	
16-pin plastic DIP	74ALS112AN	SOT38-4
16-pin plastic SO	74ALS112AD	SOT109-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

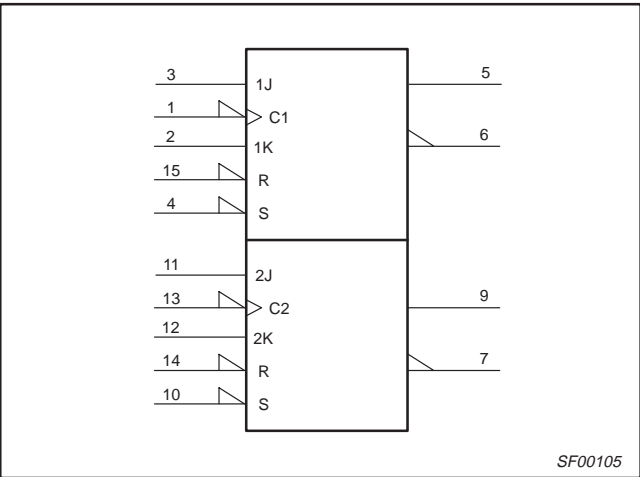
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
$\overline{CP_0}$, $\overline{CP_1}$	Clock Pulse input (active falling edge)	1.0/1.0	20 μ A/0.1mA
J0, J1	J inputs	1.0/2.0	20 μ A/0.2mA
K0, K1	K inputs	1.0/2.0	20 μ A/0.2mA
$\overline{SD_0}$, $\overline{SD_1}$	Set inputs (active-Low)	1.0/2.0	20 μ A/0.2mA
$\overline{RD_0}$, $\overline{RD_1}$	Reset inputs (active-Low)	1.0/2.0	20 μ A/0.2mA
Q0, Q1, $\overline{Q_0}$, $\overline{Q_1}$	Data outputs	20/80	0.4mA/8mA

NOTE: One (1.0) ALS unit load is defined as: 20 μ A in the High state and 0.1mA in the Low state.

LOGIC SYMBOL



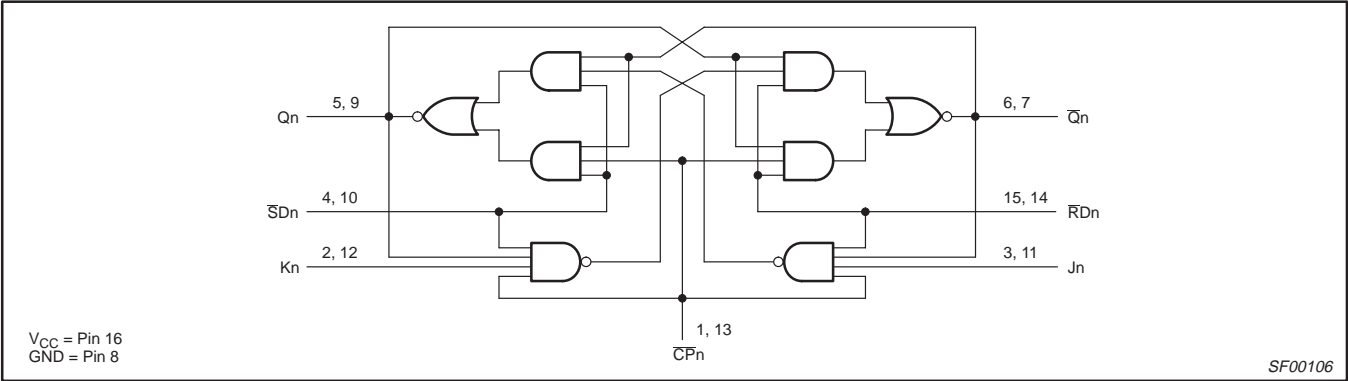
IEC/IEEE SYMBOL



Dual J-K negative edge-triggered flip-flop

74ALS112A

LOGIC DIAGRAM



FUNCTION TABLE

INPUTS					OUTPUTS		OPERATING MODE
SD	RD	CP	J	K	Q	Q	
L	H	X	X	X	H	L	Asynchronous Set
H	L	X	X	X	L	H	Asynchronous Reset
L	L	X	X	X	H*	H*	Undetermined *
H	H	↓	h	h	q	q	Toggle
H	H	↓	h	l	H	L	Load "1" (Set)
H	H	↓	l	h	L	H	Load "0" (Reset)
H	H	↓	l	l	q	q	Hold "no change"
H	H	H	X	X	q	q	Hold "no change"

H = High voltage level
h = High state must be present one setup time prior to High-to-Low clock transition
L = Low voltage level
l = Low state must be present one setup time prior to High-to-Low clock transition
q = Lower case indicate the state of the referenced output prior to the High-to-Low clock transition
X = Don't care
↓ = High-to-Low clock transition
* = Both outputs will be High while both SD and RD are Low, but the output states are unpredictable if SD and RD go High simultaneously

Asynchronous inputs: Low input to SD sets Q to High level, Low input to RD sets Q to Low level. Set and reset are independent of clock.
Simultaneous Low on both SD and RD makes both Q and Q High.

Dual J-K negative edge-triggered flip-flop

74ALS112A

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	−0.5 to +7.0	V
V_{IN}	Input voltage	−0.5 to +7.0	V
I_{IN}	Input current	−30 to +5	mA
V_{OUT}	Voltage applied to output in High output state	−0.5 to V_{CC}	V
I_{OUT}	Current applied to output in Low output state	16	mA
T_{amb}	Operating free-air temperature range	0 to +70	°C
T_{stg}	Storage temperature range	−65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			−18	mA
I_{OH}	High-level output current			−0.4	mA
I_{OL}	Low-level output current			8	mA
T_{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS ¹	LIMITS			UNIT
				MIN	TYP ²	MAX	
V_{OH}	High-level output voltage		$V_{CC} = \pm 10\%$, $V_{IL} = \text{MAX}$, $V_{IH} = \text{MIN}$	$I_{OH} = -0.4\text{mA}$	$V_{CC} - 2$		V
V_{OL}	Low-level output voltage		$V_{CC} = \text{MIN}$, $V_{IL} = \text{MAX}$,	$I_{OL} = 4\text{mA}$		0.25	V
			$V_{IH} = \text{MIN}$	$I_{OL} = 8\text{mA}$		0.35	V
V_{IK}	Input clamp voltage		$V_{CC} = \text{MIN}$, $I_I = I_{IK}$		−0.73	−1.5	V
I_I	Input current at maximum input voltage		$V_{CC} = \text{MAX}$, $V_I = 7.0\text{V}$			0.1	mA
I_{IH}	High-level input current		$V_{CC} = \text{MAX}$, $V_I = 2.7\text{V}$			20	μA
I_{IL}	Low-level input current	\overline{CPn}	$V_{CC} = \text{MAX}$, $V_I = 0.4\text{V}$			−0.1	mA
		\overline{SDn} , \overline{RDn} , Jn , Kn				−0.2	mA
I_O	Output current ³		$V_{CC} = \text{MAX}$, $V_O = 2.25\text{V}$	−30		−112	mA
I_{CC}	Supply current (total)		$V_{CC} = \text{MAX}$		2.5	4.5	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at $V_{CC} = 5\text{V}$, $T_{amb} = 25^\circ\text{C}$.
- The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

Dual J-K negative edge-triggered flip-flop

74ALS112A

AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS		UNIT
			$T_{amb} = 0^{\circ}\text{C to } +70^{\circ}\text{C}$ $V_{CC} = +5.0\text{V} \pm 10\%$ $C_L = 50\text{pF}, R_L = 500\Omega$		
			MIN	MAX	
f _{MAX}	Maximum clock frequency	Waveform 1	35		MHz
t _{PLH} t _{PHL}	Propagation delay CP _n to Q _n or Q _n	Waveform 1	2.0 4.0	10.0 10.5	ns
t _{PLH} t _{PHL}	Propagation delay SD _n or RD to Q _n or Q _n	Waveform 2, 3	1.5 3.5	8.0 9.5	ns

AC SETUP REQUIREMENTS

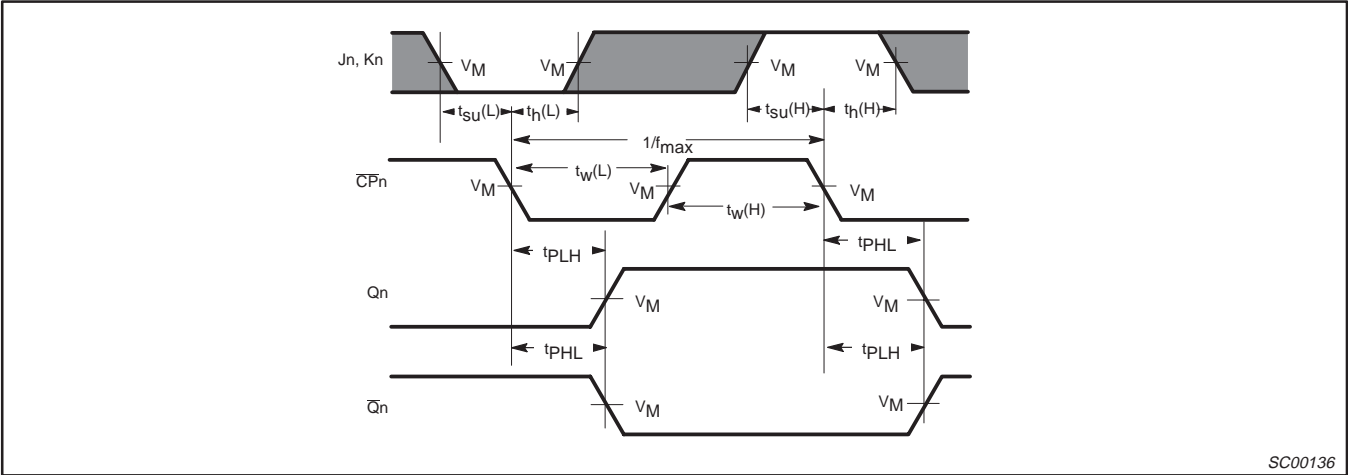
SYMBOL	PARAMETER	TEST CONDITION	LIMITS		UNIT
			$T_{amb} = 0^{\circ}\text{C to } +70^{\circ}\text{C}$ $V_{CC} = +5.0\text{V} \pm 10\%$ $C_L = 50\text{pF}, R_L = 500\Omega$		
			MIN	MAX	
$t_{su} \text{ (H)}$ $t_{su} \text{ (L)}$	Setup time, High or Low Jn, Kn to \overline{CPn}	Waveform 1	8.0 8.0		ns
$t_h \text{ (H)}$ $t_h \text{ (L)}$	Hold time, High or Low Jn, Kn to \overline{CPn}	Waveform 1	0.0 0.0		ns
$t_w \text{ (H)}$ $t_w \text{ (L)}$	\overline{CPn} Pulse width high or Low	Waveform 1	11.0 8.0		ns
$t_w \text{ (L)}$	\overline{SDn} or \overline{RDn} Pulse width Low	Waveform 2, 3	6.0		ns
t_{REC}	Recovery time, \overline{SDn} or \overline{RDn} to \overline{CPn}	Waveform 2, 3	8.0		ns

Dual J-K negative edge-triggered flip-flop

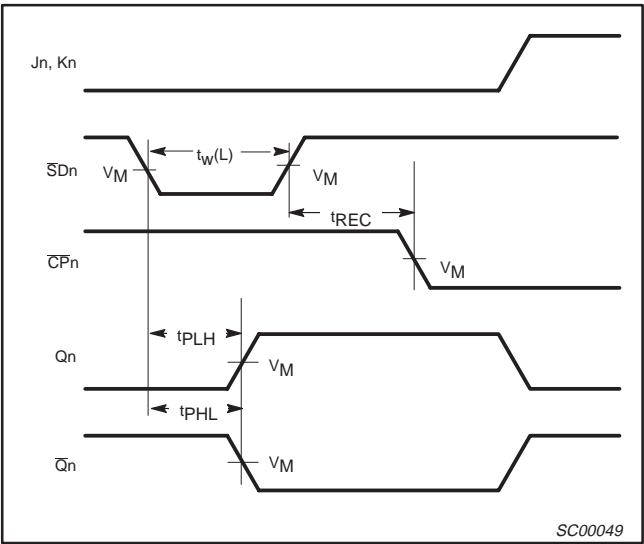
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AC WAVEFORMS

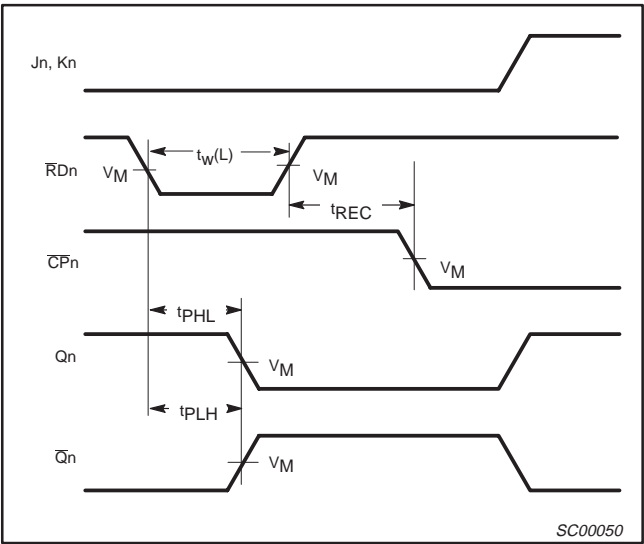
For all waveforms, $V_M = 1.3V$.
The shaded areas indicate when the input is permitted to change for predictable output performance.



Waveform 1. Propagation Delay for Data to Output, Data Setup Time and Hold Times, Clock Pulse Width, and Maximum Clock Frequency



Waveform 2. Propagation Delay for Set to Output, Set Pulse Width, and Recovery Time for Set to Clock

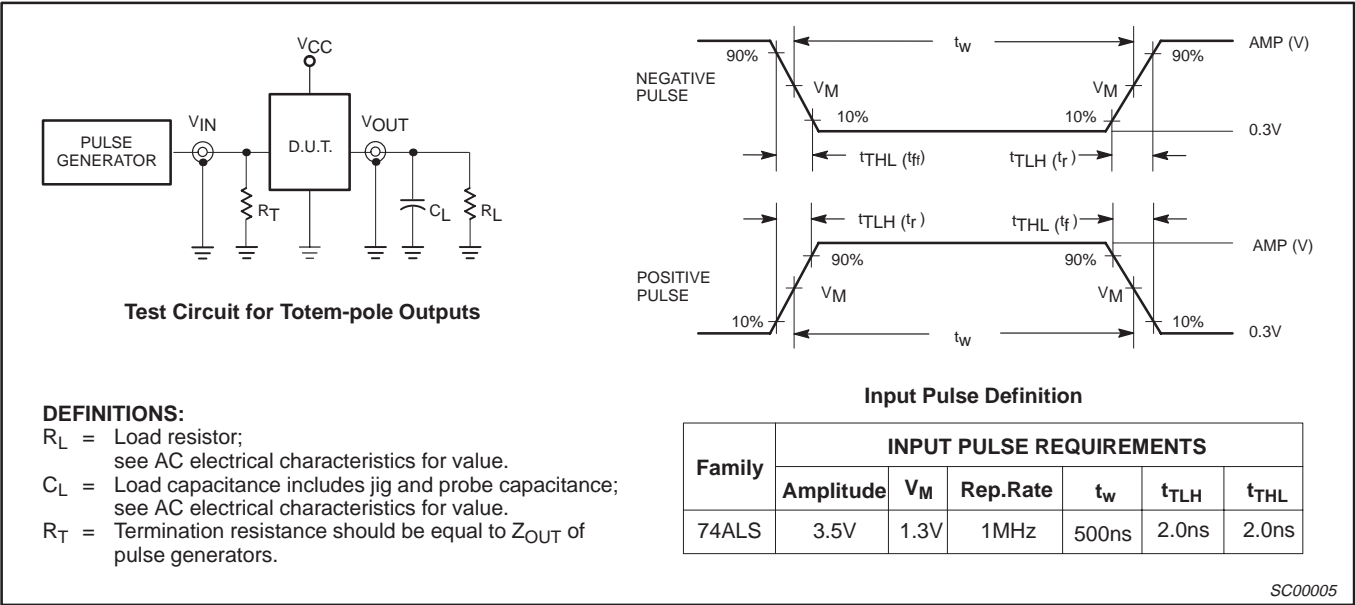


Waveform 3. Propagation Delay for Reset to Output, Reset Pulse Width, and Recovery Time for Reset to Clock

Dual J-K negative edge-triggered flip-flop

74ALS112A

TEST CIRCUIT AND WAVEFORMS

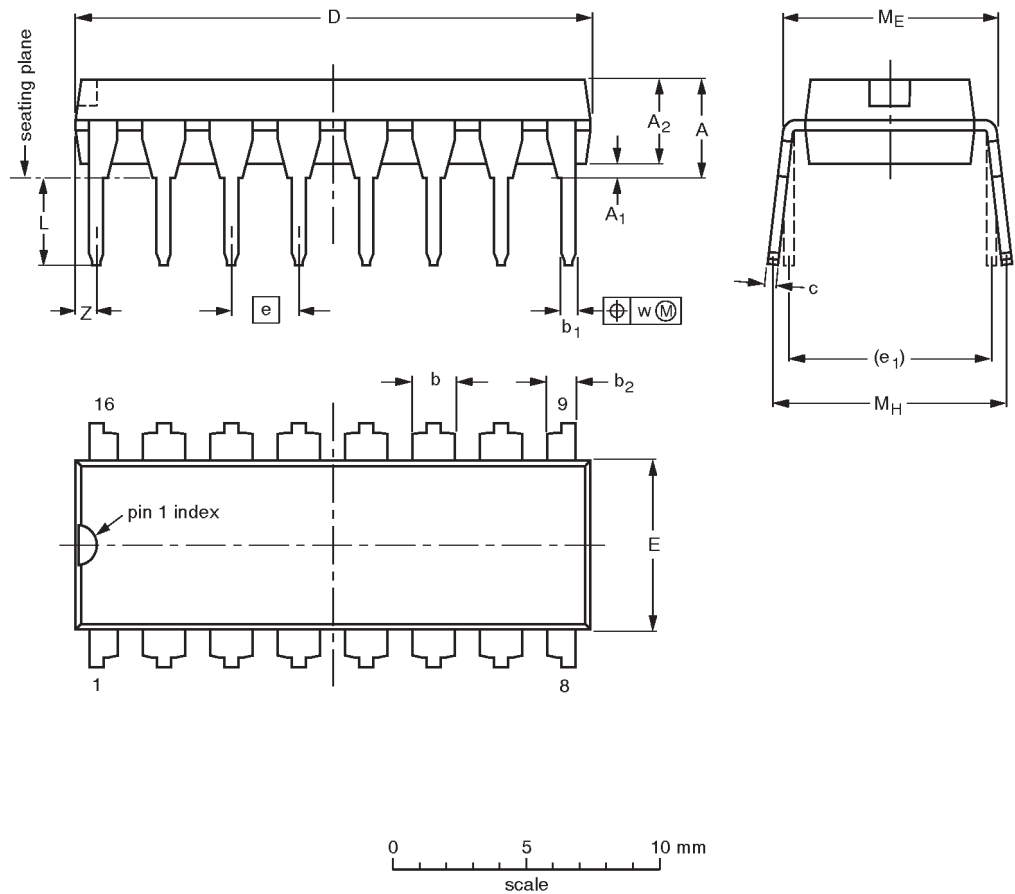


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74ALS112A

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4




DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

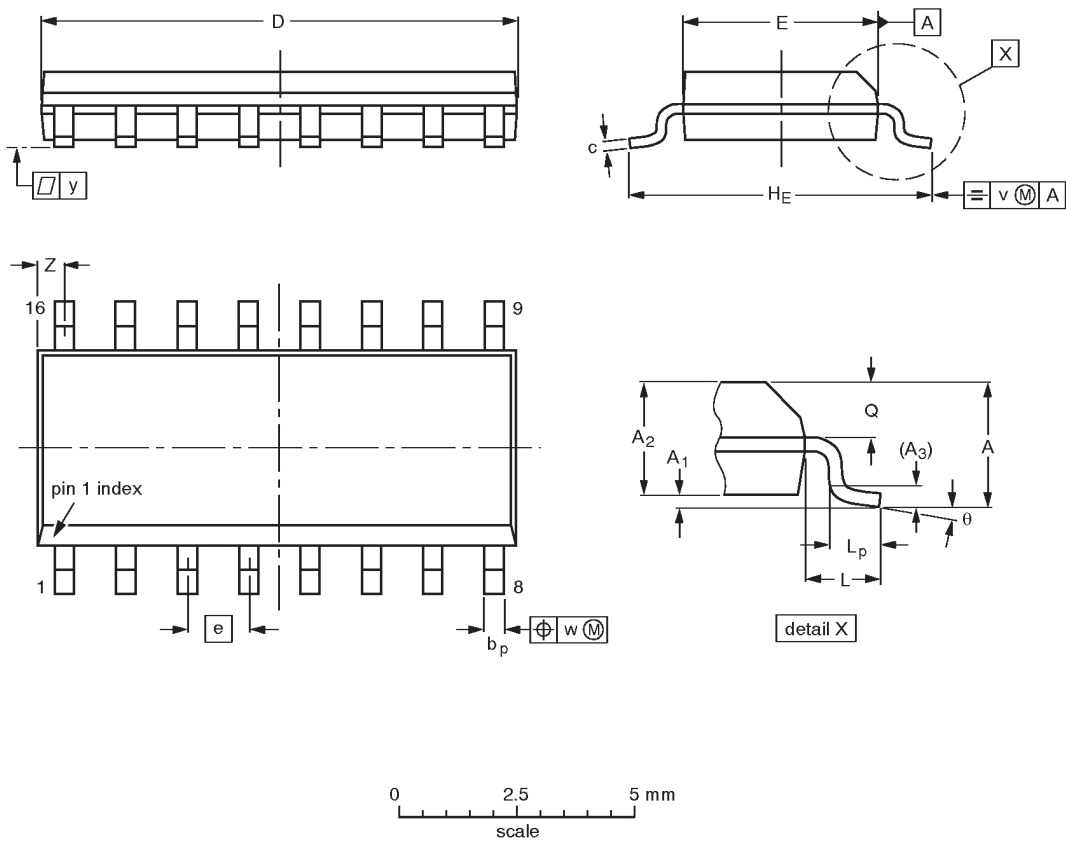
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

Dual J-K negative edge-triggered flip-flop

74ALS112A

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1




DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07S	MS-012AC				91-08-13 95-01-23

Dual J-K negative edge-triggered flip-flop

74ALS112A

DEFINITIONS		
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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